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Hirace 華州宏カ

HUA HONG SEMICONDUCTOR LIMITED

華虹半導體有限公司

(Incorporated in Hong Kong with limited liability)
(Stock Code: 1347)

VOLUNTARY ANNOUNCEMENT

Reference is made the circular of the Company dated 8 November 2021 (the "Circular") in relation to the amendments to the terms of the Share Option Scheme. Unless otherwise defined, capitalised terms used herein shall have the same meaning as those defined in the Circular.

This announcement is made by the Company on a voluntary basis to provide the shareholders of the Company and potential investors with an update on the arrangements under the Share Option Scheme.

The Board is pleased to announce that a maximum of 925,000 of the 2018 Options, 125,000 and 634,438 of the 2019 Options shall be vested on 24 December 2023, 11 August 2023 and 23 December 2023, respectively, in accordance with the terms of the Share Option Scheme as amended by the ordinary resolution of the Company's Shareholders passed at the extraordinary general meeting on 26 November 2021.

Further announcements will be made in relation to the exercise of the 2018 and 2019 Options if and when required by the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited.

By order of the Board

Hua Hong Semiconductor Limited

Mr. Suxin Zhang

Chairman and Executive Director

Hong Kong, 10 August 2023

As at the date of this announcement, the directors of the Company are:

Executive Directors:

Suxin Zhang (Chairman)
Junjun Tang (President)

Non-Executive Directors:

Guodong Sun Jing Wang Jun Ye

Independent Non-Executive Directors:

Stephen Tso Tung Chang Kwai Huen Wong, JP Long Fei Ye